


**SOP-8**
**Pin Definition:**  
1. Source  
2. Source  
3. Source  
4. Gate  
5, 6, 7, 8. Drain

**PRODUCT SUMMARY**

<b>V<sub>DS</sub> (V)</b>	<b>R<sub>DS(on)</sub>(mΩ)</b>	<b>I<sub>D</sub> (A)</b>
30	11.5 @ V <sub>GS</sub> = 10V	12.5
	16.5 @ V <sub>GS</sub> = 4.5V	10

**Features**

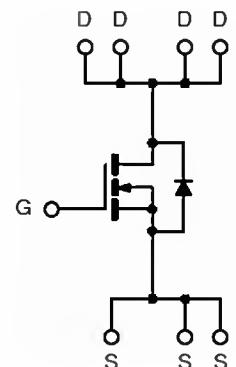
- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

**Application**

- High-Side DC/DC Conversion
- Notebook
- Server

**Ordering Information**

<b>Part No.</b>	<b>Package</b>	<b>Packing</b>
TSM4392CS RL	SOP-8	2.5Kpcs / 13" Reel

**Block Diagram**

**N-Channel MOSFET**
**Absolute Maximum Rating (Ta = 25°C unless otherwise noted)**

<b>Parameter</b>	<b>Symbol</b>	<b>Limit</b>	<b>Unit</b>
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	12.5	A
Pulsed Drain Current	I <sub>DM</sub>	50	A
Continuous Source Current (Diode Conduction) <sup>a,b</sup>	I <sub>S</sub>	2.7	A
Maximum Power Dissipation	T <sub>a</sub> = 25°C	3.0	W
		1.9	
Operating Junction Temperature	T <sub>J</sub>	+150	°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	- 55 to +150	°C

**Thermal Performance**

<b>Parameter</b>	<b>Symbol</b>	<b>Limit</b>	<b>Unit</b>
Junction to Case Thermal Resistance	R<θ <sub>JF</sub>	25	°C/W
Junction to Ambient Thermal Resistance (PCB mounted)	R<θ <sub>JA</sub>	50	°C/W

Notes:

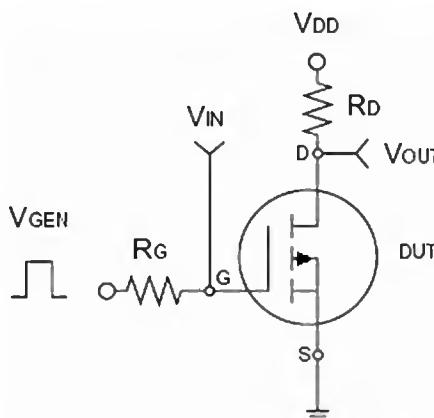
- a. Pulse width limited by the Maximum junction temperature
- b. Surface Mounted on FR4 Board, t ≤ 10 sec.

## Electrical Specifications (Ta = 25°C unless otherwise noted)

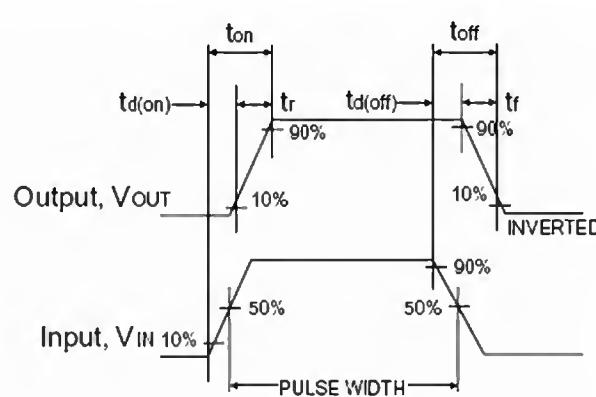
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	BV <sub>DSS</sub>	30	--	--	V
Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	V <sub>GS(TH)</sub>	1	1.8	3	V
Gate Body Leakage	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	I <sub>GSS</sub>	--	--	±100	nA
Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24V, V <sub>GS</sub> = 0V	I <sub>DSS</sub>	--	--	1.0	μA
On-State Drain Current <sup>a</sup>	V <sub>DS</sub> ≥ 5V, V <sub>GS</sub> = 10V	I <sub>D(ON)</sub>	30	--	--	A
Drain-Source On-State Resistance <sup>a</sup>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 12.5A	R <sub>DS(ON)</sub>	--	9	11.5	mΩ
	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A		--	13	16.5	
Forward Transconductance <sup>a</sup>	V <sub>DS</sub> = 15V, I <sub>D</sub> = 12.5A	g <sub>fs</sub>	--	40	--	S
Diode Forward Voltage	I <sub>S</sub> = 2.7A, V <sub>GS</sub> = 0V	V <sub>SD</sub>	--	0.85	1.3	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	V <sub>DS</sub> = 15V, I <sub>D</sub> = 12.5A, V <sub>GS</sub> = 10V	Q <sub>g</sub>	--	26	--	nC
Gate-Source Charge		Q <sub>gs</sub>	--	6	--	
Gate-Drain Charge		Q <sub>gd</sub>	--	5	--	
Input Capacitance	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, f = 1.0MHz	C <sub>iss</sub>	--	2134	--	pF
Output Capacitance		C <sub>oss</sub>	--	343	--	
Reverse Transfer Capacitance		C <sub>rss</sub>	--	134	--	
<b>Switching<sup>c</sup></b>						
Turn-On Delay Time	V <sub>DD</sub> = 15V, R <sub>L</sub> = 15Ω, I <sub>D</sub> = 1A, V <sub>GEN</sub> = 10V, R <sub>G</sub> = 6Ω	t <sub>d(on)</sub>	--	17	--	nS
Turn-On Rise Time		t <sub>r</sub>	--	3.5	--	
Turn-Off Delay Time		t <sub>d(off)</sub>	--	40	--	
Turn-Off Fall Time		t <sub>f</sub>	--	6	--	

## Notes:

- a. pulse test: PW ≤300μS, duty cycle ≤2%
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

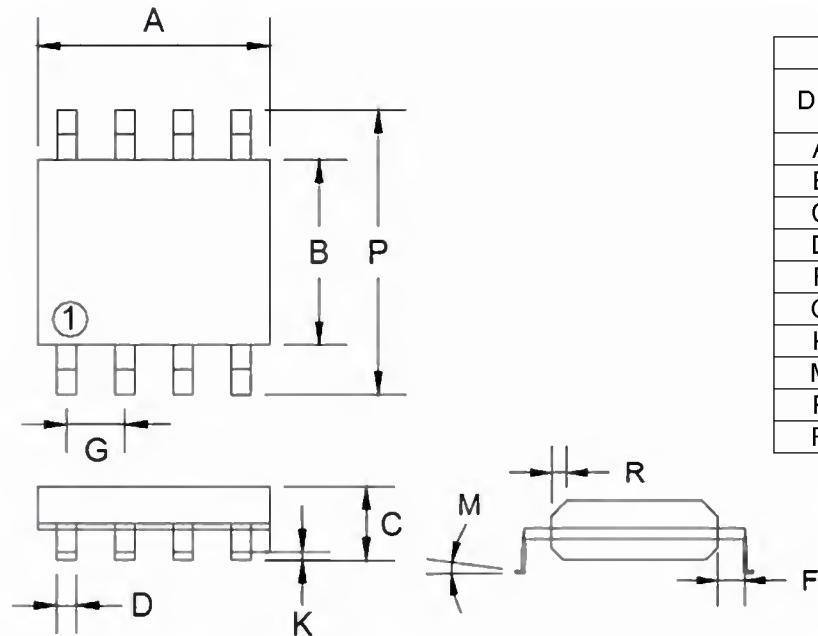


Switching Test Circuit



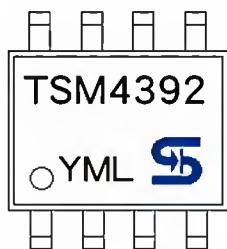
Switching Waveforms

## SOP-8 Mechanical Drawing



SOP-8 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX.
A	4.80	5.00	0.189	0.196
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27BSC		0.05BSC	
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

## Marking Diagram



**Y** = Year Code  
**M** = Month Code  
 (A=Jan, B=Feb, C=Mar, D=Apl, E=May, F=Jun, G=Jul, H=Aug,  
 I=Sep, J=Oct, K=Nov, L=Dec)  
**L** = Lot Code



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